Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM6J06FU

Power Management Switch High-Speed Switching Applications

- Small package
- Low ON-resistance: RDS(ON) = $0.5~\Omega$ max (VGS = -4 V)

: $R_{DS(ON)} = 0.7 \Omega \text{ max} (V_{GS} = -2.5 \text{ V})$

• Low gate threshold voltage

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DS}	-20	V	
Gate-source voltage		V _{GSS}	±12	V	
Drain current	DC	ID	-650	mA	
	Pulse	I _{DP}	-1300	ША	
Power dissipation		P _D	300	mW	
		(Note 1)	300		
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

1, 2, 5, 6 : DRAIN
3 : GATE
4 : SOURCE

US6

JEDEC —

JEITA —

TOSHIBA 2-2J1D

Weight: 6.8 mg (typ.)

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

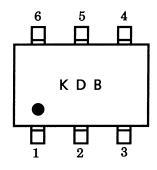
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board.

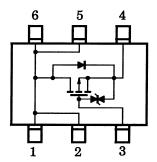
 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu pad: } 0.32 \text{ mm}^2 \times 6)$

Please refer to Figure 1.

Marking



Equivalent Circuit



Handling Precaution

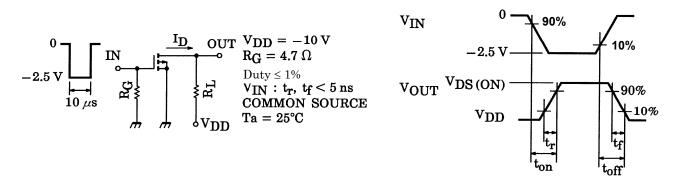
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C)

Chara	Characteristics Symbol Test Condition		Min	Тур.	Max	Unit	
Gate leakage curr	tte leakage current I_{GSS} $V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$		_	_	±1	μА	
Drain-source brea	kdown voltage	V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$		_	_	V
Drain cut-off curre	cut-off current I_{DSS} $V_{DS} = -20 \text{ V}, V_{GS} = 0$		_	_	-1	μА	
Gate threshold vo	ate threshold voltage V_{th} $V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$		$V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$	-0.6	_	-1.1	V
Forward transfer admittance		Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -0.3 \text{ A}$ (Note 2)	0.6	_	_	S
Drain-source ON-resistance		R _{DS (ON)}	$I_D = -0.3 \text{ A}, V_{GS} = -4 \text{ V}$ (Note 2	<u> </u>	0.4	0.5	Ω
			$I_D = -0.3 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note 2)	<u> </u>	0.55	0.7	
Input capacitance		C _{iss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	160	_	pF
Reverse transfer of	rse transfer capacitance C_{rss} $V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	25	_	pF	
Output capacitance		Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	90	_	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -10 \text{ V}, I_D = -0.3 \text{ A},$ $V_{GS} = 0 \text{ to } -2.5 \text{ V}, R_G = 4.7 \Omega$	_	27	_	ns
	Turn-off time	t _{off}		_	43	_	

Note 2: Pulse test

Switching Time Test Circuit

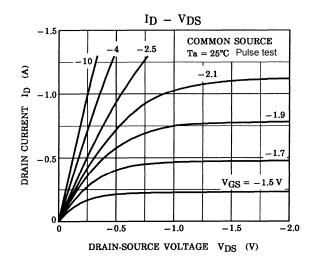


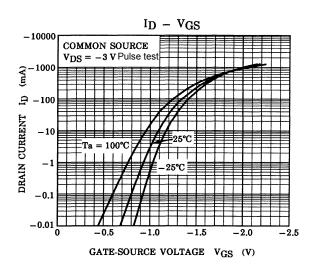
Precaution

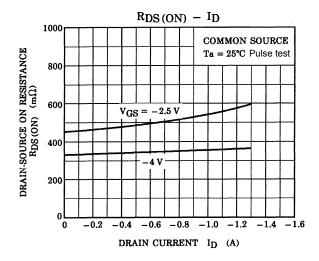
 V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = -100~\mu A$ for this product. For normal switching operation, V_{GS} (on) requires higher voltage than V_{th} and V_{GS} (off) requires lower voltage than V_{th} .

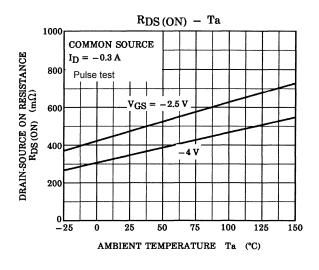
(Relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on))

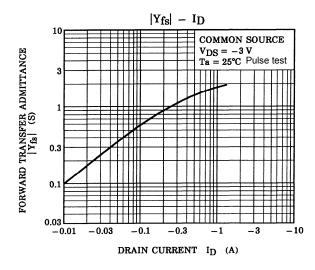
Please take this into consideration for using the device.

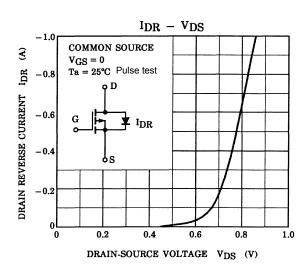




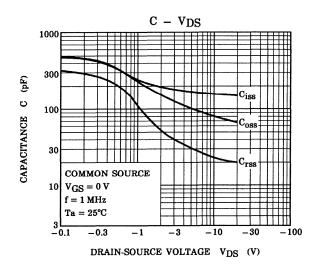


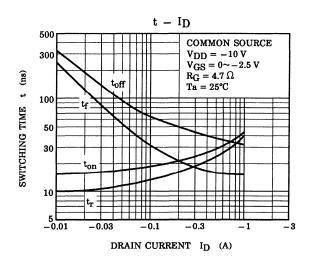


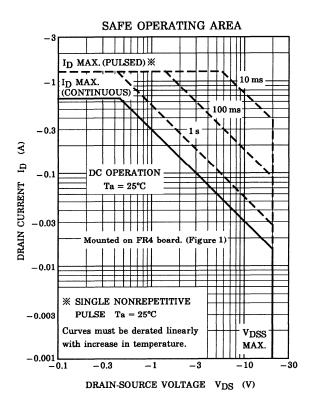


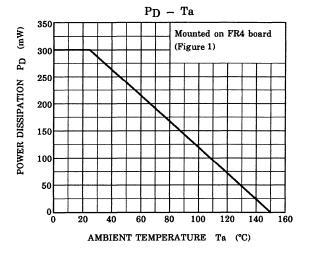


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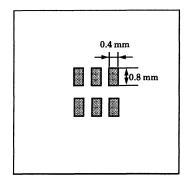


Figure 1 25.4 mm \times 25.4 mm \times 1.6 mm, Cu Pad: 0.32 mm² \times 6

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